80 V, 1 A NPN medium power transistors Rev. 9 — 25 October 2011

#### **Product profile** 1.

#### 1.1 General description

NPN medium power transistor series in Surface-Mounted Device (SMD) plastic packages.

#### **Product overview** Table 1.

Type number <sup>[1]</sup>	Package	Package		
	Nexperia	JEITA	JEDEC	
BCP56	SOT223	SC-73	-	BCP53
BCX56	SOT89	SC-62	TO-243	BCX53
BC56PA	SOT1061	-	-	BC53PA

[1] Valid for all available selection groups.

#### 1.2 Features and benefits

- High current
- Three current gain selections
- High power dissipation capability
- Exposed heatsink for excellent thermal and electrical conductivity (SOT89, SOT1061)
- Leadless very small SMD plastic package with medium power capability (SOT1061)
- AEC-Q101 gualified

#### **1.3 Applications**

- Linear voltage regulators
- Low-side switches
- Battery-driven devices
- Power management
- MOSFET drivers
- Amplifiers

#### 1.4 Quick reference data

#### Table 2. Quick reference data

Symbol	Parameter	Conditions	Min	Тур	Мах	Unit
$V_{CEO}$	collector-emitter voltage	open base	-	-	80	V
I <sub>C</sub>	collector current		-	-	1	А
I <sub>CM</sub>	peak collector current	single pulse; $t_p \leq 1\ ms$	-	-	2	А
h <sub>FE</sub>	DC current gain	$V_{CE} = 2 V; I_{C} = 150 mA$	[ <u>1]</u> 63	-	250	
	h <sub>FE</sub> selection -10	$V_{CE} = 2 \text{ V}; I_{C} = 150 \text{ mA}$	<u>[1]</u> 63	-	160	
	h <sub>FE</sub> selection -16	$V_{CE} = 2 \text{ V}; I_{C} = 150 \text{ mA}$	[ <u>1]</u> 100	-	250	

[1] Pulse test:  $t_p \le 300 \ \mu s$ ;  $\delta = 0.02$ .

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### 2. Pinning information

Pin	Description	Simplified outline	Graphic symbol
SOT223			
1	base		
2	collector		2, 4
3	emitter		1
4	collector		3 sym016
SOT89			
1	emitter		
2	collector		2 J
3	base		31 sym042
SOT1061			
1	base		_
2	emitter	3	3
3	collector		1 2 sym021
		1   2     Transparent top view	- <i>j j</i>

### 3. Ordering information

Table 4. Ordering information							
Type number <sup>[1]</sup>	Package						
	Name	Description	Version				
BCP56	SC-73	plastic surface-mounted package with increased heatsink; 4 leads	SOT223				
BCX56	SC-62	plastic surface-mounted package; exposed die pad for good heat transfer; 3 leads	SOT89				
BC56PA	HUSON3	plastic thermal enhanced ultra thin small outline package; no leads; 3 terminals; body $2 \times 2 \times 0.65$ mm	SOT1061				

[1] Valid for all available selection groups.

BCP56\_BCX56\_BC56PA

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### 4. Marking

Table 5.   Marking codes	
Type number	Marking code
BCP56	BCP56
BCP56-10	BCP56/10
BCP56-16	BCP56/16
BCX56	ВН
BCX56-10	ВК
BCX56-16	BL
BC56PA	AZ
BC56-10PA	ВК
BC56-16PA	BL

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#### 5. Limiting values

Symbol	nce with the Absolute Maximur Parameter	Conditions	Min	Max	Unit
V <sub>CBO</sub>	collector-base voltage	open emitter	-	100	V
V <sub>CEO</sub>	collector-emitter voltage	open base	-	80	V
V <sub>EBO</sub>	emitter-base voltage	open collector	-	5	V
lc	collector current		-	1	А
I <sub>CM</sub>	peak collector current	single pulse; t <sub>p</sub> ≤ 1 ms	-	2	А
I <sub>B</sub>	base current		-	0.3	А
I <sub>BM</sub>	peak base current	single pulse; t <sub>p</sub> ≤ 1 ms	-	0.3	А
P <sub>tot</sub>	total power dissipation	$T_{amb} \le 25 \ ^{\circ}C$			
	BCP56		<u>[1]</u> _	0.65	W
			[2] _	1.00	W
			[3]	1.35	W
	BCX56		<u>[1]</u> _	0.50	W
			[2] _	0.95	W
			[3]	1.35	W
	BC56PA		<u>[1]</u> _	0.42	W
			[2] _	0.83	W
			[3]	1.10	W
			[4]	0.81	W
			[5]	1.65	W
Tj	junction temperature		-	150	°C
T <sub>amb</sub>	ambient temperature		-55	+150	°C
T <sub>stg</sub>	storage temperature		-65	+150	°C

[1] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and standard footprint.

 $\label{eq:compared} \ensuremath{\left[2\right]} \quad \mbox{Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for collector 1 cm^2.$ 

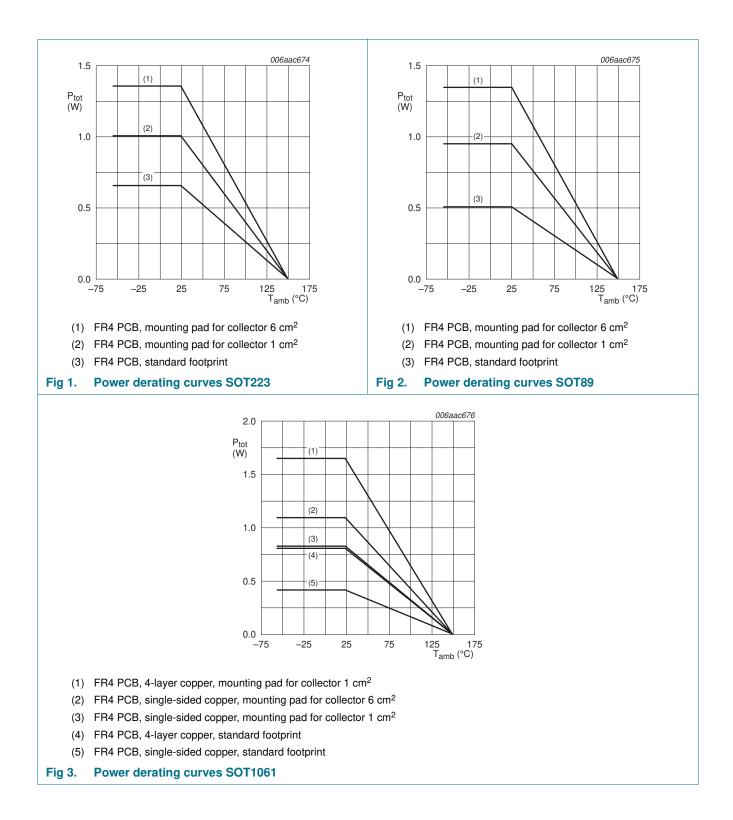
[3] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for collector 6 cm<sup>2</sup>.

[4] Device mounted on an FR4 PCB, 4-layer copper, tin-plated and standard footprint.

[5] Device mounted on an FR4 PCB, 4-layer copper, tin-plated, mounting pad for collector 1 cm<sup>2</sup>.

# BCP56; BCX56; BC56PA

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BCP56\_BCX56\_BC56PA

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#### 6. Thermal characteristics

Table 7.	Thermal characteristics					
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
R <sub>th(j-a)</sub>	thermal resistance from junction to ambient	in free air				
	BCP56		[1] -	-	192	K/W
			[2] -	-	125	K/W
			[3] _	-	93	K/W
	BCX56		<u>[1]</u> -	-	250	K/W
			[2] _	-	132	K/W
			[3] _	-	93	K/W
	BC56PA		<u>[1]</u> -	-	298	K/W
			[2] _	-	151	K/W
			<u>[3]</u> _	-	114	K/W
			[4] _	-	154	K/W
			<u>[5]</u> _	-	76	K/W
R <sub>th(j-sp)</sub>	thermal resistance from junction to solder point					
	BCP56		-	-	16	K/W
	BCX56		-	-	16	K/W
	BC56PA		-	-	20	K/W

[1] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.

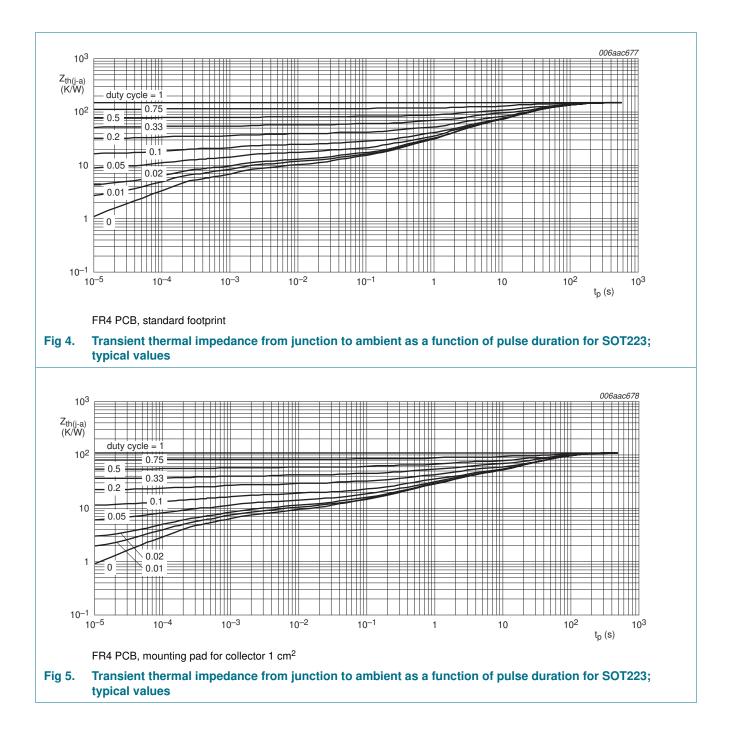
[2] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for collector 1 cm<sup>2</sup>.

[3] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for collector 6 cm<sup>2</sup>.

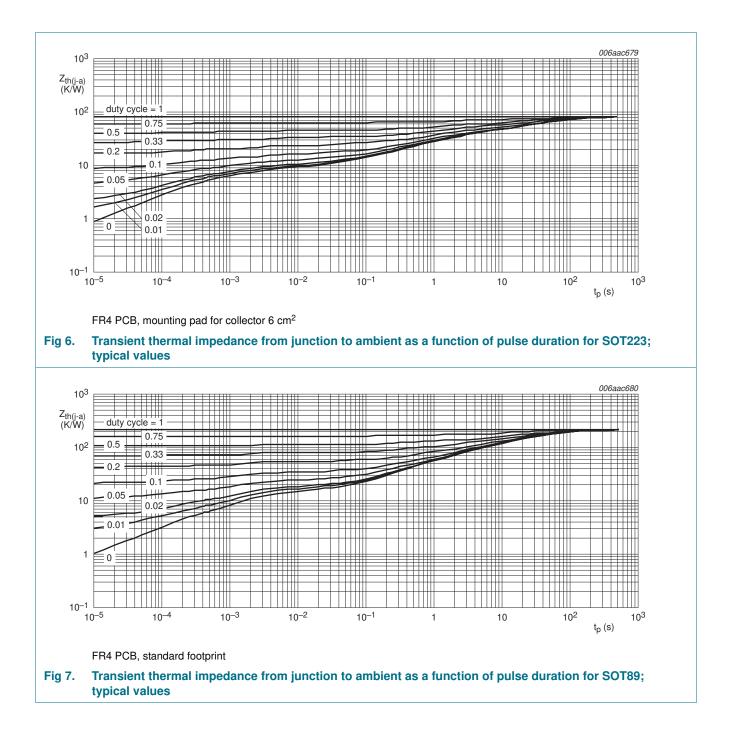
[4] Device mounted on an FR4 PCB, 4-layer copper, tin-plated and standard footprint.

[5] Device mounted on an FR4 PCB, 4-layer copper, tin-plated, mounting pad for collector 1 cm<sup>2</sup>.

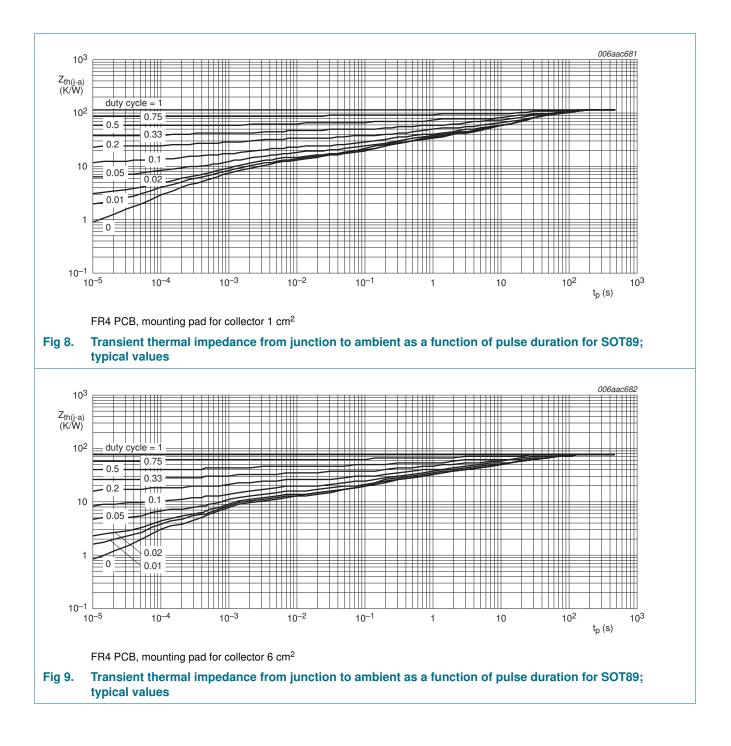
### BCP56; BCX56; BC56PA



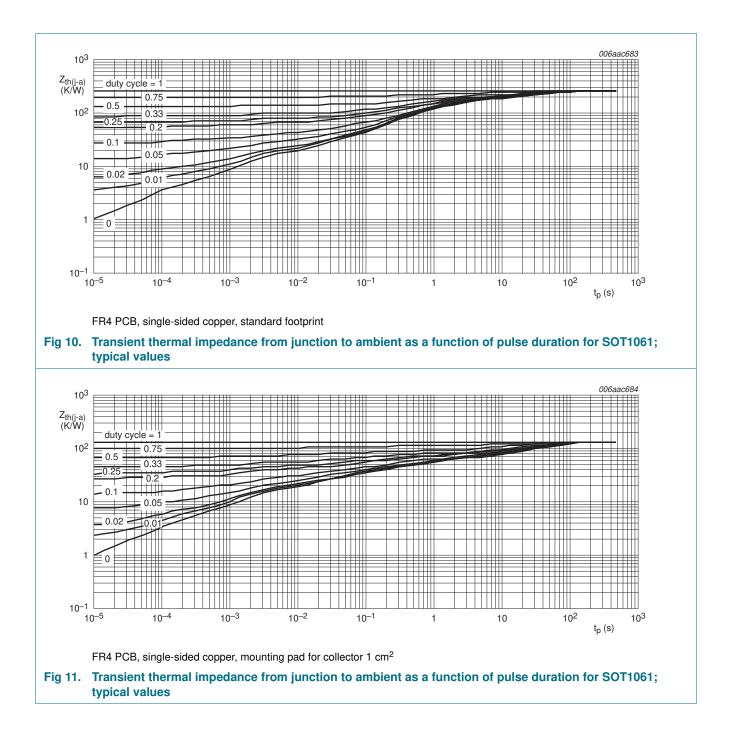
### BCP56; BCX56; BC56PA



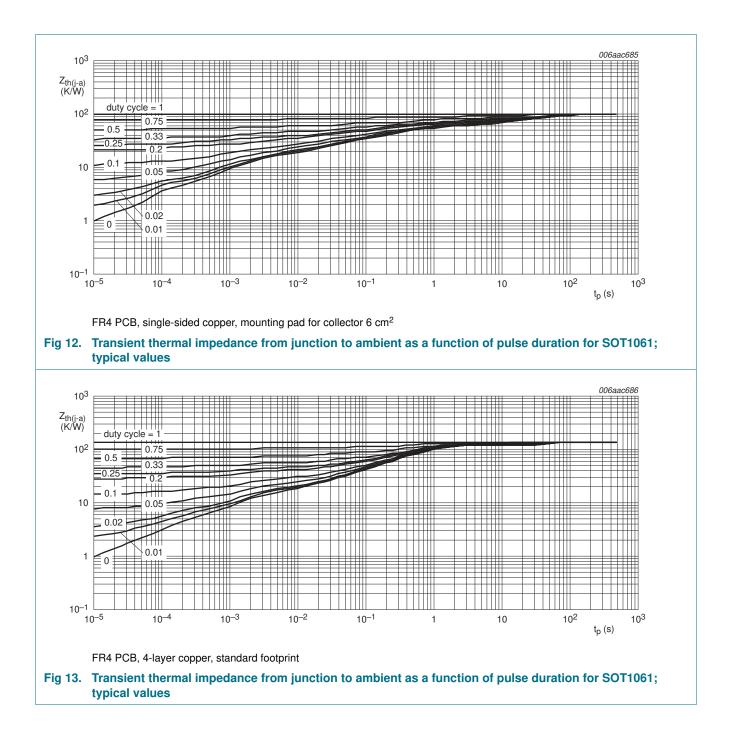
### BCP56; BCX56; BC56PA



### BCP56; BCX56; BC56PA

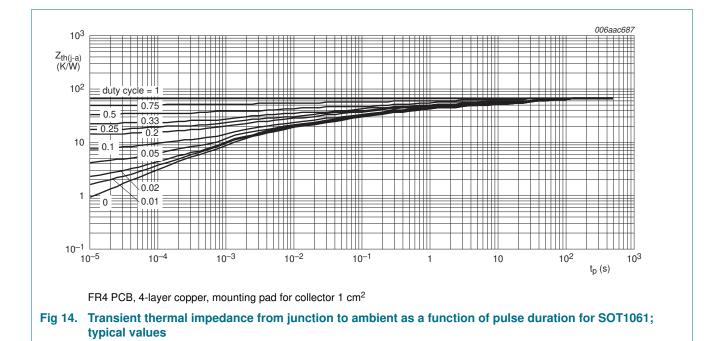


### BCP56; BCX56; BC56PA



### BCP56; BCX56; BC56PA

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#### 7. Characteristics

#### Table 8. Characteristics

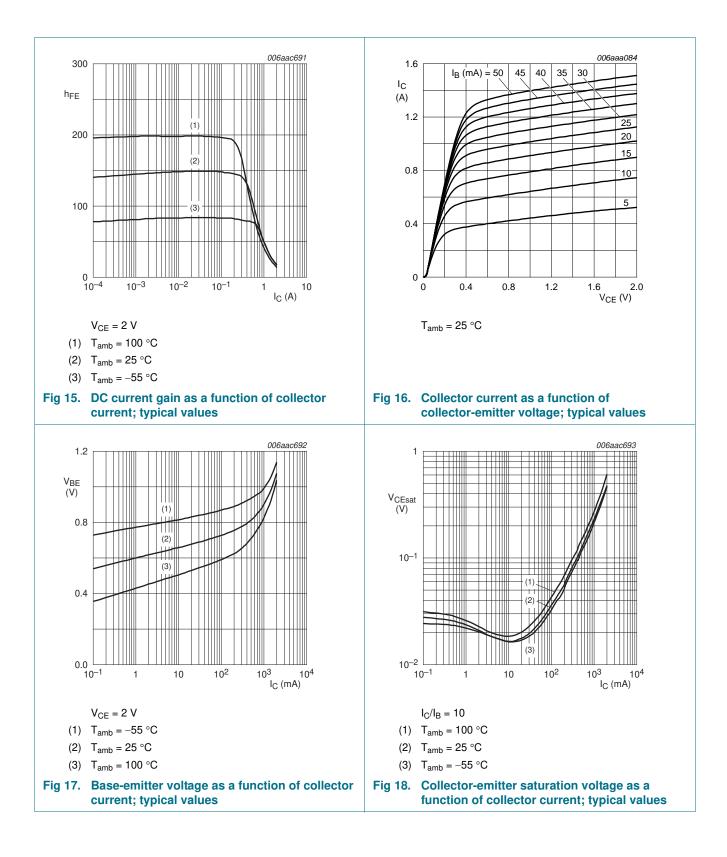
T<sub>amb</sub> = 25 °C unless otherwise specified.

				_		
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
I <sub>CBO</sub>	collector-base cut-off	$V_{CB}$ = 30 V; $I_E$ = 0 A	-	-	100	nA
	current	$\label{eq:VCB} \begin{array}{l} V_{CB} = 30 \ V; \ I_E = 0 \ A; \\ T_j = 150 \ ^\circC \end{array}$	-	-	10	μA
I <sub>EBO</sub>	emitter-base cut-off current	$V_{EB} = 5 \text{ V}; \text{ I}_{C} = 0 \text{ A}$	-	-	100	nA
h <sub>FE</sub> DC current gain		$V_{CE} = 2 V$				
	$I_{\rm C} = 5  \rm{mA}$	<mark>[1]</mark> 63	-	-		
		I <sub>C</sub> = 150 mA	<mark>[1]</mark> 63	-	250	
DC current gain	I <sub>C</sub> = 500 mA	<u>1</u> 40	-	-		
	$V_{CE} = 2 V$					
	h <sub>FE</sub> selection -10	I <sub>C</sub> = 150 mA	<mark>[1]</mark> 63	-	160	
	h <sub>FE</sub> selection -16	I <sub>C</sub> = 150 mA	<u>1</u> 100	-	250	
V <sub>CEsat</sub>	collector-emitter saturation voltage	$I_{\rm C} = 500 \text{ mA}; I_{\rm B} = 50 \text{ mA}$	[1] -	-	0.5	V
V <sub>BE</sub>	base-emitter voltage	$V_{CE} = 2 \text{ V}; \text{ I}_{C} = 500 \text{ mA}$	[1] -	-	1	V
C <sub>c</sub>	collector capacitance	$\label{eq:VCB} \begin{array}{l} V_{CB} = 10 \text{ V};  \text{I}_{E} = \text{i}_{e} = 0 \text{ A}; \\ \text{f} = 1 \text{ MHz} \end{array}$	-	6	-	pF
f⊤	transition frequency	$V_{CE} = 5 \text{ V}; \text{ I}_{C} = 50 \text{ mA};$ f = 100 MHz	100	180	-	MHz

[1] Pulse test:  $t_p \le 300 \ \mu s$ ;  $\delta = 0.02$ .

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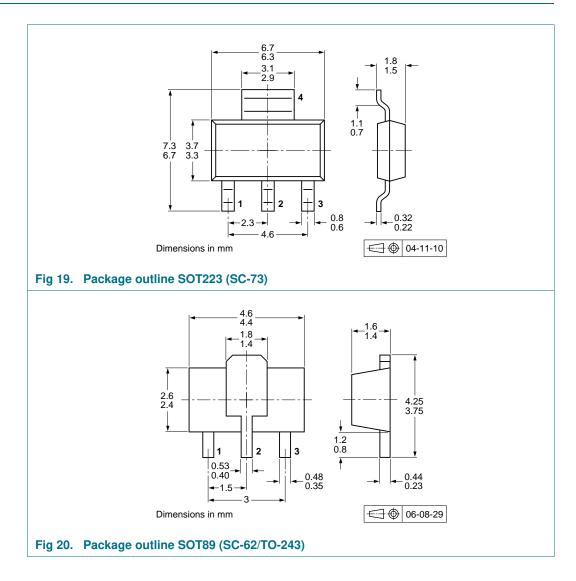
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#### 8. Test information

#### 8.1 Quality information

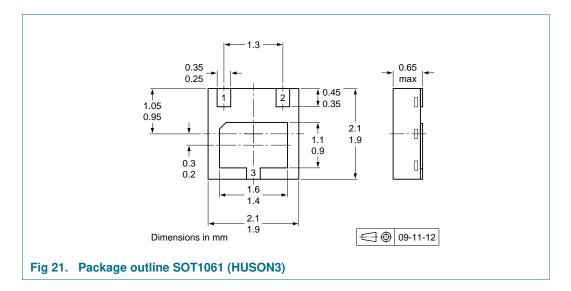
This product has been qualified in accordance with the Automotive Electronics Council (AEC) standard *Q101* - *Stress test qualification for discrete semiconductors*, and is suitable for use in automotive applications.

#### 9. Package outline



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#### **10. Packing information**

#### Table 9. Packing methods

The indicated -xxx are the last three digits of the 12NC ordering code.[1]

Туре	Package Description			Packing quantity		
number <sup>[2]</sup>				1000	3000	4000
BCP56	SOT223	8 mm pitch, 12 mm tape and reel		-115	-	-135
BCX56 SOT89		8 mm pitch, 12 mm tape and reel; T1	[3]	-115	-	-135
		8 mm pitch, 12 mm tape and reel; T3	[4]	-146	-	-
BC56PA	SOT1061	4 mm pitch, 8 mm tape and reel		-	-115	-

[1] For further information and the availability of packing methods, see <u>Section 14</u>.

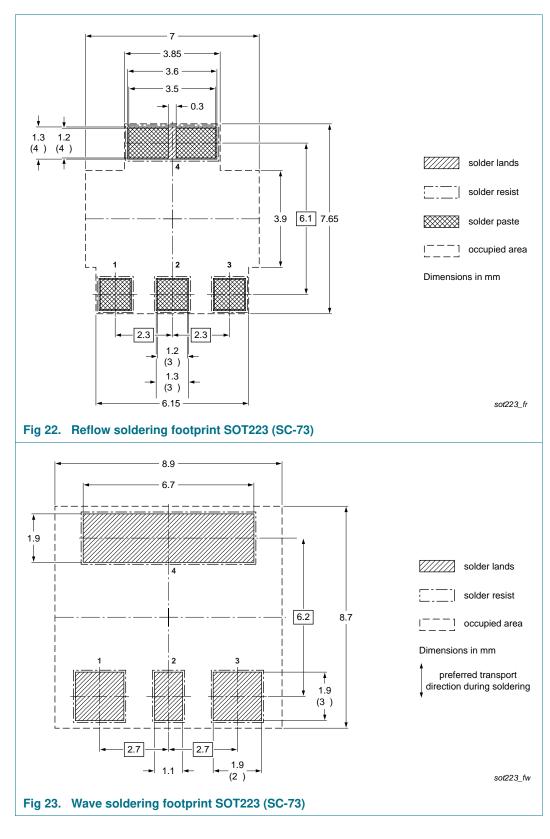
[2] Valid for all available selection groups.

- [3] T1: normal taping
- [4] T3: 90° rotated taping

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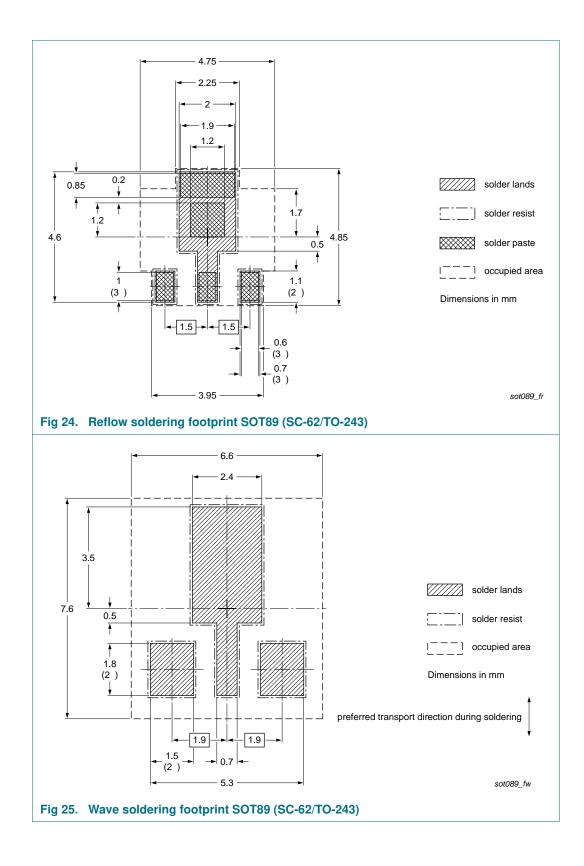
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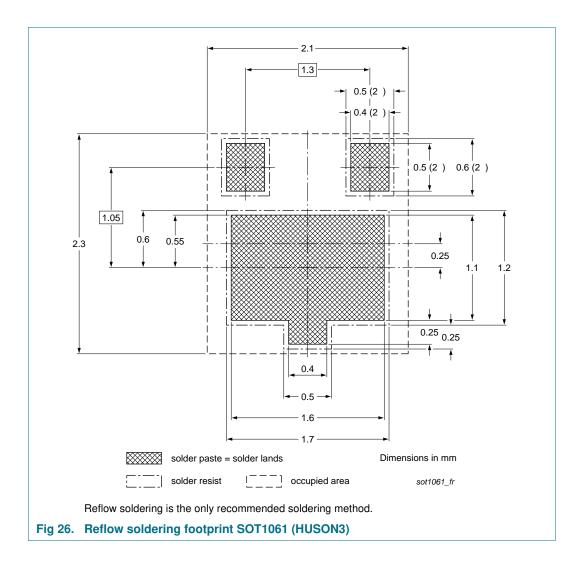
#### 11. Soldering



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### **12. Revision history**

#### Table 10.Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes			
BCP56_BCX56_BC56PA v.9	20111025	Product data sheet	-	BC639_BCP56_BCX56 v.8			
Modifications:	Type numb	er removed: BC639					
	<ul> <li>Type number added: BC56PA, BC56-10PA and BC56-16PA</li> </ul>						
	<ul> <li>Section 1 "F</li> </ul>	Product profile": updated					
	<ul> <li>Section 2 "F</li> </ul>	Pinning information": upd	ated				
	• <u>Table 6</u> and	I <u>7</u> : updated according to	latest measuremen	ts			
	<ul> <li>Figure 1, 2,</li> </ul>	<u>4</u> , <u>5</u> , <u>7</u> to <u>9</u> , <u>15</u> , <u>17</u> and <u>1</u>	8: updated				
	<ul> <li>Figure 3, 6,</li> </ul>	10 to 14: added					
	<u>Section 8 "Test information"</u> : added						
	<ul> <li><u>Section 10 "Packing information"</u>: updated</li> </ul>						
	<ul> <li>Section 11</li> </ul>	"Soldering": added					
	Section 13	"Legal information": upda	ited				
BC639_BCP56_BCX56 v.8	20070622	Product data sheet	-	BC639_BCP56_BCX56 v.7			
BC639_BCP56_BCX56 v.7	20050308	Product data sheet	-	BC639_BCP56_BCX56 v.6			
BC639_BCP56_BCX56 v.6	20050303	Product data sheet	CPCN2004050	BC635_637_639 v.4			
			29	BCP54_55_56 v.5			
D0005 007 000 v 4	00011010	Draduct on edification		BCX54_55_56 v.4			
BC635_637_639 v.4	20011010	Product specification	-	BC635_637_639 v.3			
BCP54_55_56 v.5	20030206	Product specification	-	BCP54_55_56 v.4			
BCX54_55_56 v.4	20011010	Product specification	-	BCX54_55_56 v.3			

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#### **13. Legal information**

#### 13.1 Data sheet status

Document status[1][2]	Product status <sup>[3]</sup>	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

[3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL http://www.nexperia.com.

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Product data sheet

F

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**Quick reference data** — The Quick reference data is an extract of the product data given in the Limiting values and Characteristics sections of this document, and as such is not complete, exhaustive or legally binding.

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#### 14. Contact information

For more information, please visit: http://www.nexperia.com

For sales office addresses, please send an email to: salesaddresses@nexperia.com

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